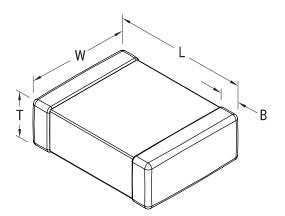
KEMET Part Number: C1206X335K3RAC



SMD Comm X7R Flex, Ceramic, 3.3 uF, 10%, 25 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1206



Dimensions		
Chip Size	1206	
L	3.3mm +/-0.4mm	
W	1.6mm +/-0.35mm	
Т	1.6mm +/-0.20mm	
В	0.6mm +/-0.25mm	

Packaging Specifications	
Packaging:	Bulk, Bag
Packaging Quantity:	1

General Information	
Series:	SMD Comm X7R Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Temperature Stable
Features:	FT-CAP, Temperature Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	41 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications		
Capacitance:	3.3 uF	
Measurement Condition:	1 kHz 1.0Vrms	
Capacitance Tolerance:	10%	
Voltage DC:	25 VDC	
Dielectric Withstanding Voltage:	62.5 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms	
Dissipation Factor:	10% 1 kHz 1.0Vrms	
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance:	30.3 MOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



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